IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Luo et al.

Serial No.: 10/826.985

Filed: April 19, 2004

FOR: METHODS FOR FORMING PROTECTIVE LAYERS ON SEMICONDUCTOR DEVICE COMPONENTS SO AS TO REDUCE OR ELIMINATE THE OCCURENCE OF DELAMINATION THEREOF AND CRACKING THEREIN

Confirmation No.: 3493

Examiner: J. Stark

Group Art Unit: 2823

Attorney Docket No.: 2269-5565.1US

VIA ELECTRONIC FILING June 27, 2007

AMENDMENT

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Examiner:

This Amendment follows the Notice of Non-Compliant Amendment of June 5, 2007, the shortened statutory period for response to which expires on July 7, 2007.

A listing of claims, in which revisions to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 7 of this paper.